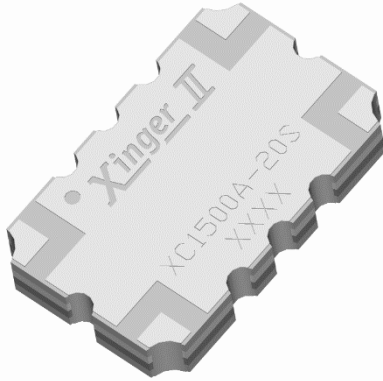


Xinger[®]

20dB Directional Coupler



Description:

The XC1500A-20S is a low profile, high performance 20dB directional coupler in a new easy to use, manufacturing friendly surface mount package. It is designed for AMPS band applications. The XC1500A-20S is designed particularly for power and frequency detection, as well as for VSWR monitoring, where tightly controlled coupling and low insertion loss is required. It can be used in high power applications up to 160 Watts.

Parts have been subjected to rigorous qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, G-10, RF-35, RO4350 and polyimide. Produced with 6 of 6 RoHS compliant tin immersion finish.

Features:

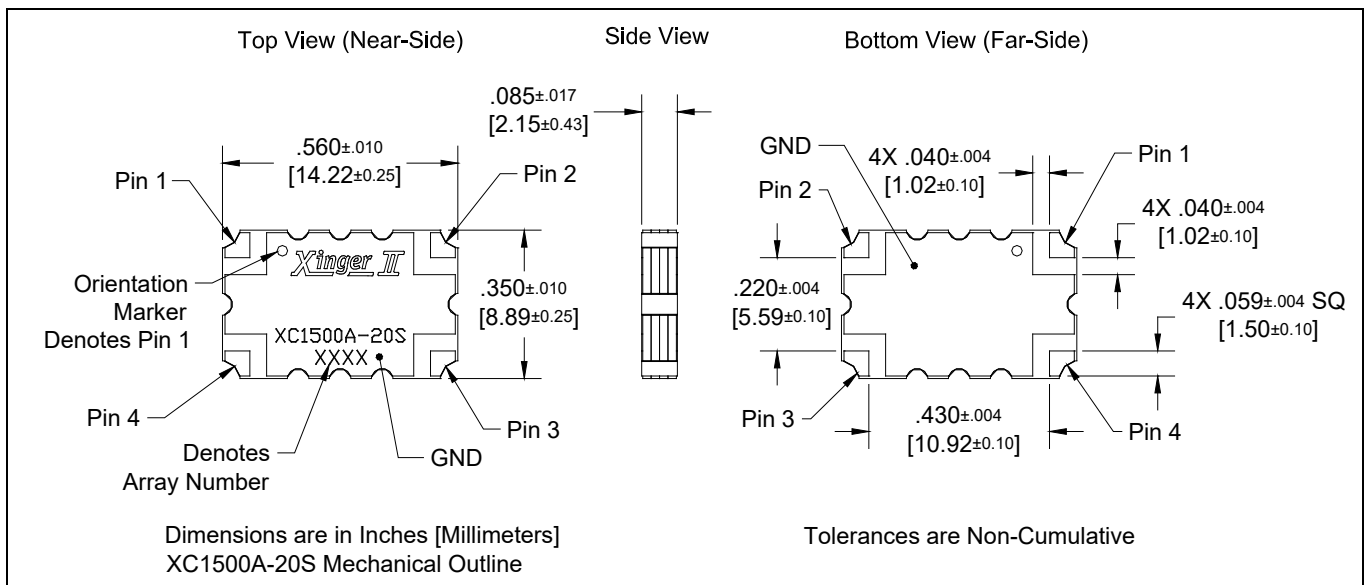
- 1000 - 2000 MHz
- AMPS
- High Power
- Very Low Loss
- Tight Coupling
- High Directivity
- Production Friendly
- Tape and Reel
- Lead-Free

Electrical Specifications**

Frequency	Mean Coupling	Insertion Loss	VSWR
<i>MHz</i>	<i>dB</i>	<i>dB Max</i>	<i>Max : 1</i>
1000-2000	20±0.70	0.19	1.28
Directivity	Frequency Sensitivity	Power	Operating Temp.
<i>dB Min</i>	<i>dB Max</i>	<i>Avg. CW Watts</i>	<i>°C</i>
21.0	±1.25	160	-55 to +85

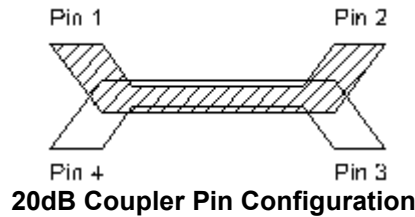
**Specification based on performance of unit properly installed on TTM Technologies Test Board 54606-0003. Refer to Specifications subject to change without notice. Refer to parameter definitions for details.

Mechanical Outline:



Directional Coupler Pin Configuration

The XC1500A-20S has an orientation marker to denote Pin 1. Once port one has been identified the other ports are known automatically. Please see the chart below for clarification.

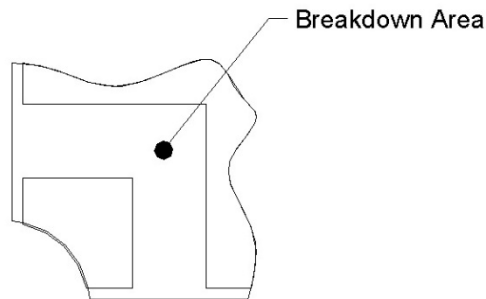


Pin 1	Pin 2	Pin 3	Pin 4
Input	Direct	Isolated	Coupled
Direct	Input	Coupled	Isolated

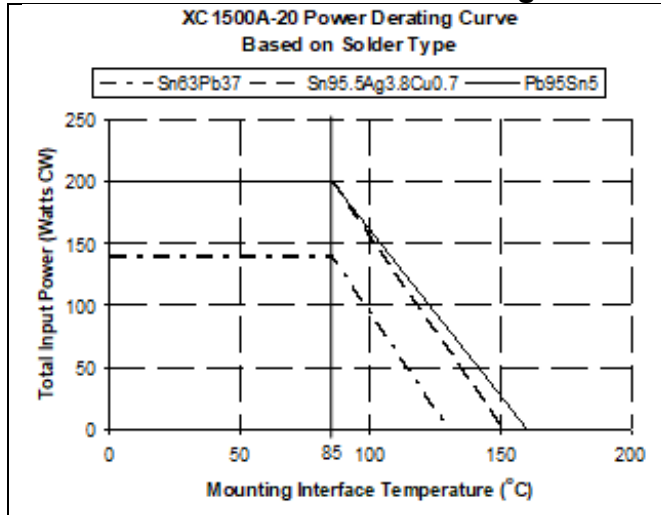
Note: The direct port has a DC connection to the input port and the coupled port has a DC connection to the isolated port. For optimum performance use Pin 1 or Pin 2 as inputs.

Peak Power

High-Pot testing of these couplers during the qualification procedure resulted in a minimum breakdown voltage of 1.91kv (minimum recorded value). This voltage level corresponds to a breakdown resistance capable of handling at least 12dB peaks over average power levels, for very short durations. The breakdown location consistently occurred across the air interface at the coupler contact pads (see illustration below). The breakdown levels at these points will be affected by any contamination in the gap area around these pads. These areas must be kept clean for optimum performance. It is recommended that the user test for voltage breakdown under the maximum operating conditions and over worst case modulation induced power peaking. This evaluation should also include extreme environmental conditions (such as high humidity).



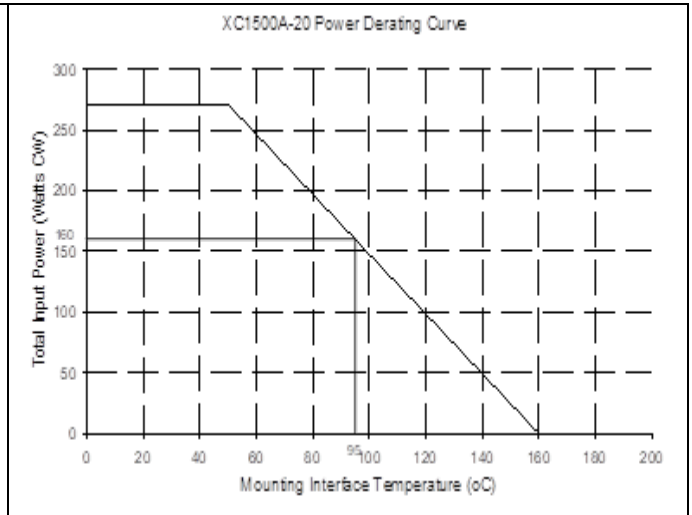
Insertion Loss and Power Derating Curves



Power Derating Based on Solder Type

The power derating plots above are a function of the thermal resistance, mounting interface temperature, maximum continuous operating temperature of the coupler, thermal insertion loss, and the maximum operating temperature of the solder type used for mounting. The thermal insertion loss is defined in the Power Handling section of the data sheet.

As the mounting interface temperature approaches the maximum continuous operating temperature of the coupler or the maximum operating temperature of the solder, the power handling decreases to zero.



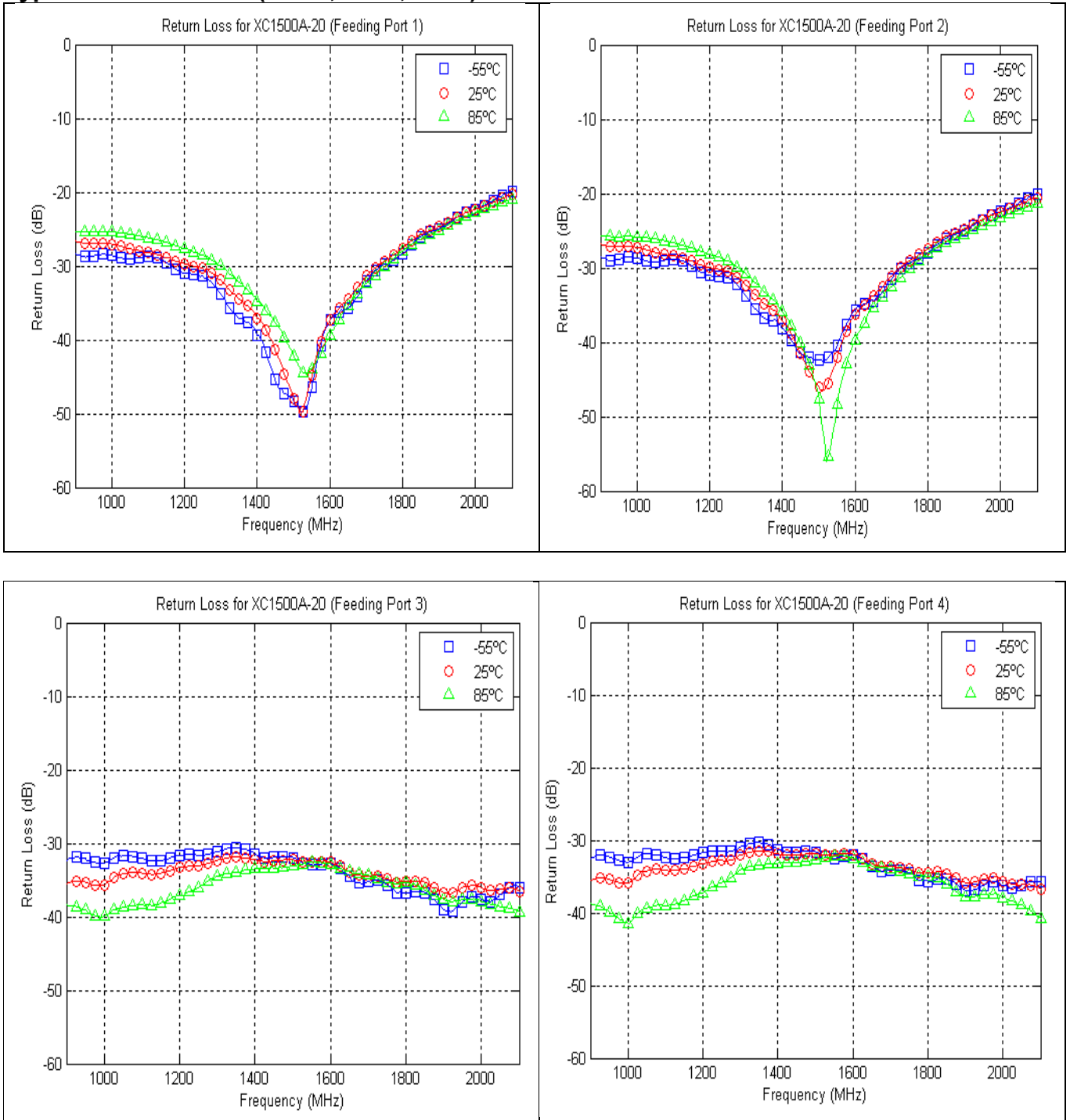
Power Derating

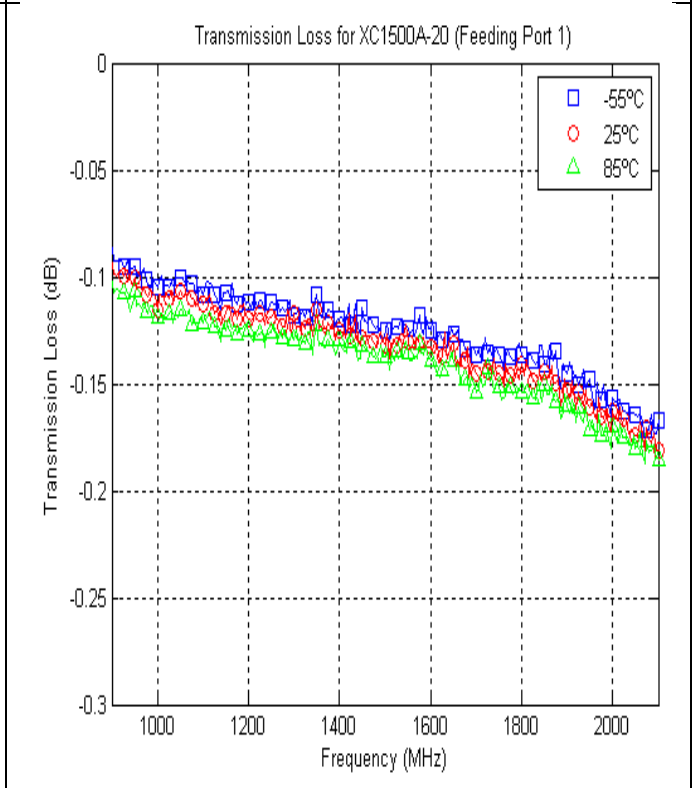
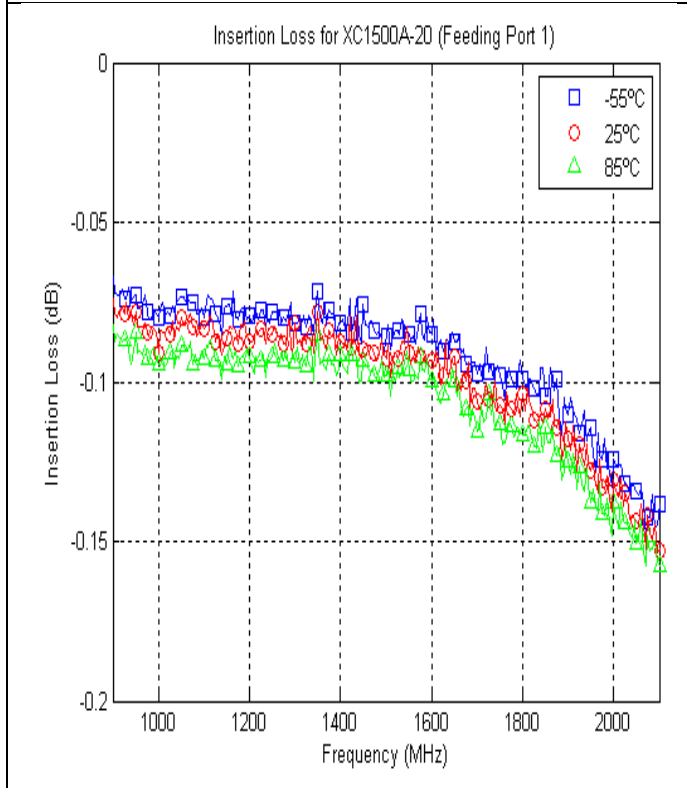
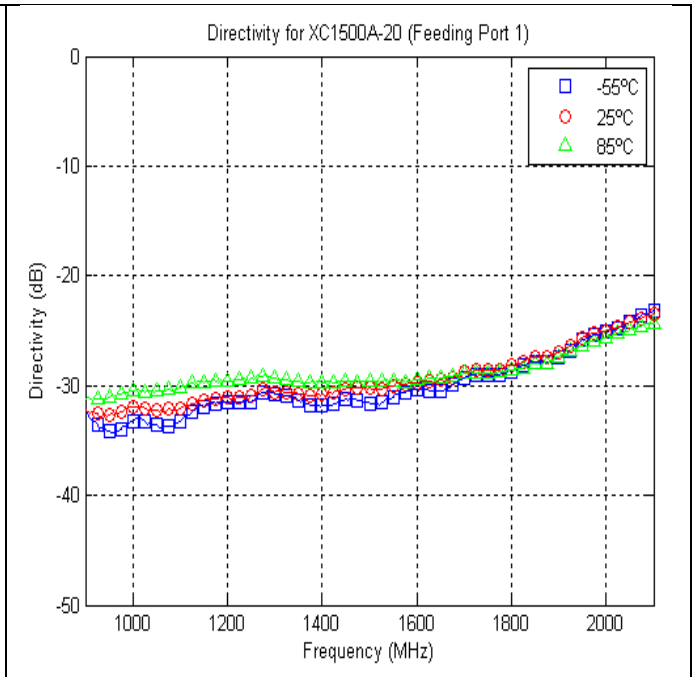
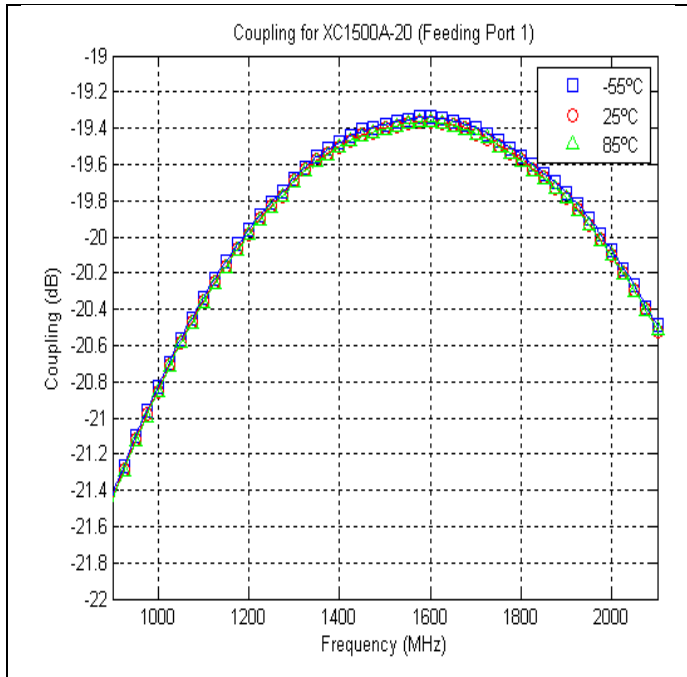
The power handling and corresponding power derating plot is a function of the thermal resistance, mounting interface temperature, maximum continuous operating temperature of the coupler, and the thermal insertion loss. The thermal insertion loss is defined in the Power Handling section of the data sheet.

As the mounting interface temperature approaches the maximum continuous operating temperature, the power handling decreases to zero.

This power derating does not take into account the type of solder used for mounting the part to the substrate.

Typical Performance (-55°C, 25°C, 85°C): 900-2100 MHz





Definition of Measured Specifications

Parameter	Definition	Mathematical Representation
VSWR (Voltage Standing Wave Ratio)	The impedance match of the coupler to a 50Ω system. A VSWR of 1:1 is optimal.	$VSWR = \frac{V_{max}}{V_{min}}$ Vmax = voltage maxima of a standing wave Vmin = voltage minima of a standing wave
Return Loss	The impedance match of the coupler to a 50Ω system. Return Loss is an alternate means to express VSWR.	$Return\ Loss(dB) = 20\log \frac{VSWR + 1}{VSWR - 1}$
Mean Coupling	At a given frequency (ω_n), coupling is the input power divided by the power at the coupled port. Mean coupling is the average value of the coupling values in the band. N is the number of frequencies in the band.	$Coupling(dB) = C(\omega_n) = 10\log \frac{P_{in}(\omega_n)}{P_{cpl}(\omega_n)}$ $Mean\ Coupling(dB) = \frac{\sum_{n=1}^N C(\omega_n)}{N}$
Insertion Loss	The input power divided by the sum of the power at the two output ports.	$10\log \frac{P_{in}}{P_{cpl} + P_{direct}}$
Transmission Loss	The input power divided by the power at the direct port.	$10\log \frac{P_{in}}{P_{direct}}$
Directivity	The power at the coupled port divided by the power at the isolated port.	$10\log \frac{P_{cpl}}{P_{iso}}$
Frequency Sensitivity	The decibel difference between the maximum in band coupling value and the mean coupling, and the decibel difference between the minimum in band coupling value and the mean coupling.	Max Coupling (dB) – Mean Coupling (dB) and Min Coupling (dB) – Mean Coupling (dB)